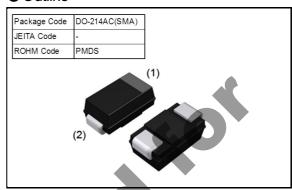
ROHM

Schottky Barrier Diode

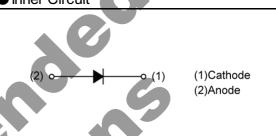
| V _R | 30 | V |
|------------------|----|---|
| l _o | 2 | Α |
| I _{FSM} | 60 | Α |

Outline



Features

High reliability Small power mold type Low V_F and low I_R Inner Circuit



ApplicationGeneral rectification

Structure
Silicon epitaxial planar

Packaging Specifications

| 3 3 1 | | | | | |
|--------------------------|---------------|--|--|--|--|
| Packing | Embossed Tape | | | | |
| Reel Size(mm) | 180 | | | | |
| Taping Width(mm) | 12 | | | | |
| Basic Ordering Unit(pcs) | 1500 | | | | |
| Taping Code | TE25 | | | | |
| Marking | 58 | | | | |
| | | | | | |

● Absolute Maximum Ratings (T_a=25°C unless otherwise specified)

| Parameter | Symbol | Conditions | Limits | Unit |
|-------------------------------------|------------------|--|------------------|------|
| Repetitive peak reverse voltage | V _{RM} | Duty≦0.5 | 30 | V |
| Reverse voltage | V _R | Reverse direct voltage | 30 | V |
| Average rectified forward current | lo | Glass epoxy mounted, 60Hz half sin waveform, resistive load, T _c =95°c Max. | 2 | Α |
| Peak forward surge current | I _{FSM} | 60Hz half sin waveform, Non-repetitive, one cycle, T _a =25°c | 60 | Α |
| Junction temperature ⁽¹⁾ | Tj | - | 150 | °C |
| Storage temperature | T _{stg} | - | -40 ~ 150 | °C |

Note(1) To avoid occurrence of thermal runaway, actual board is to be designed to fulfill dP_d/dT_j<1/R_{th(j-a)}.

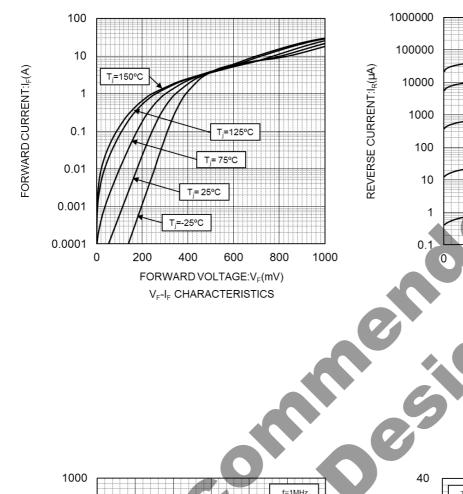
Characteristics (T_a=25°C unless otherwise specified)

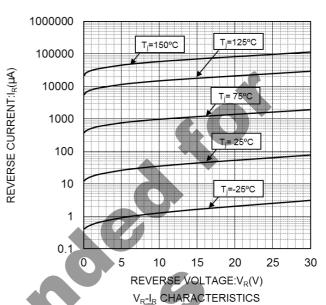
| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|-----------------|---------|---------------------|------|------|------|------|
| Forward voltage | V_{F} | I _F =2A | - | - | 0.49 | V |
| Reverse current | I_{R} | V _R =30V | - | - | 200 | μA |

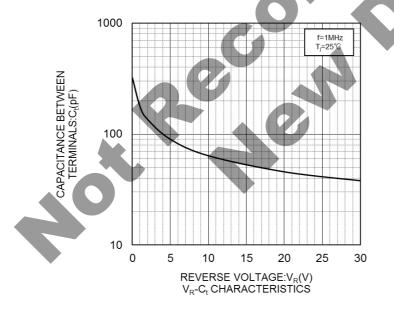
Attention

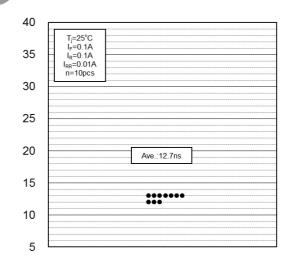
Compared with PN junction diodes, Schottky Barrier Diode is generally high reverse current (IR). The reverse loss of the diode might increase as temperature increasing that causes heat-up and further IR. This phenomenon might end up the thermal destruction(thermal runaway). Therefore please give consideration to the reverse loss and the ambient temperature when using this product.

Characteristic Curves





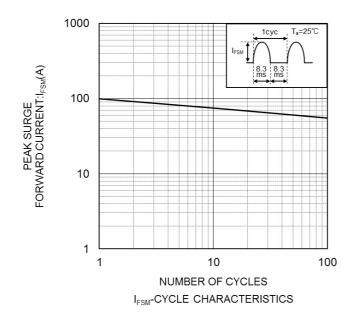


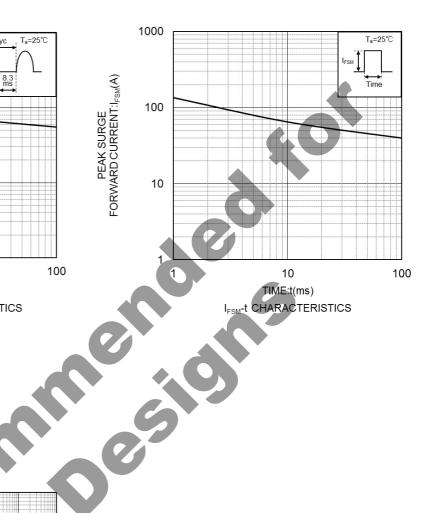


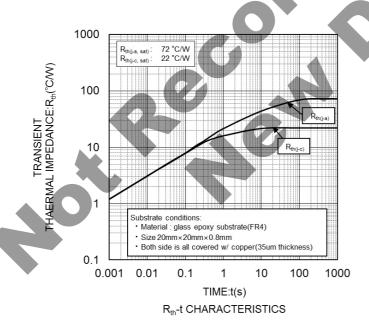
trr DISPERSION MAP

REVERSE RECOVERY TIME:t_n(ns)

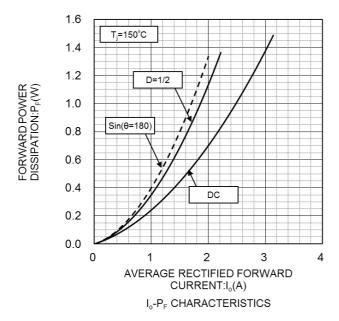
Characteristic Curves

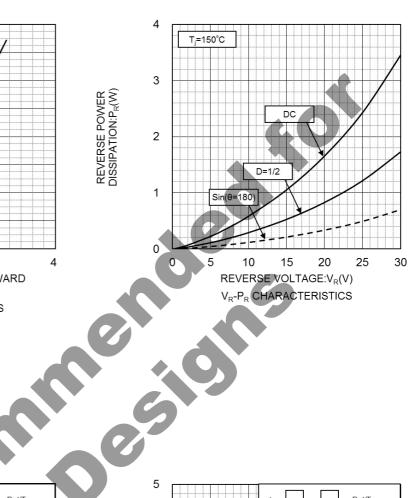






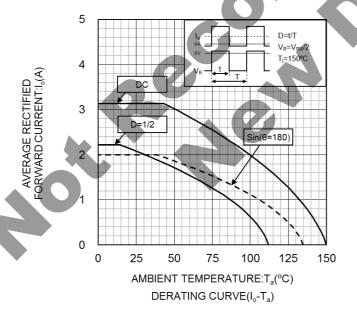
Characteristic Curves

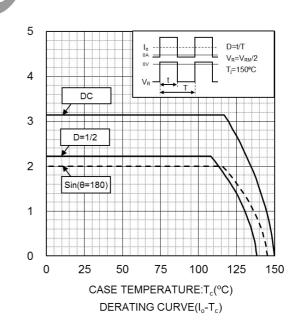




REVERSE POWER DISSIPATION:P_R(W)

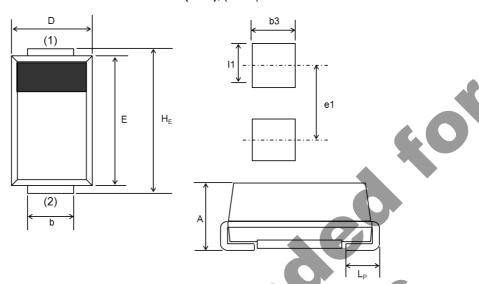
AVERAGE RECTIFIED FORWARD CURRENT:1_o(A)





Dimensions

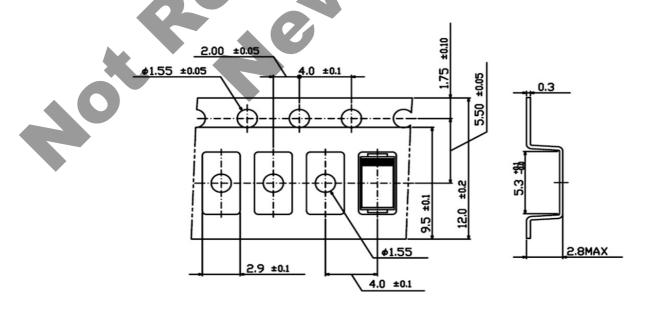
DO-214AC(SMA), (PMDS)



| DIM | Milimeters | | | Inches | | |
|----------------|------------|---------|------|--------|---------|-------|
| DIIVI | Min. | Average | Max. | Min. | Average | Max. |
| Α | 1.80 | 2.00 | 2.20 | 0.071 | 0.079 | 0.087 |
| b | 1.30 | 1.50 | 1.70 | 0.051 | 0.059 | 0.067 |
| D | 2.40 | 2.60 | 2.80 | 0.094 | 0.102 | 0.110 |
| E | 4.30 | 4.50 | 4.70 | 0.169 | 0.177 | 0.185 |
| H _E | 4.70 | 5.00 | 5.30 | 0.185 | 0.197 | 0.209 |
| L _P | 0.90 | 1.20 | 1.50 | 0.035 | 0.047 | 0.059 |
| l1 | - | 2.00 | | - | 0.079 | Ò |
| b3 | - | 2.00 | | - | 0.079 | - |
| e1 | - | 4.20 | - | - | 0.165 | - |

- (1) The marking bar indicates the cathode.(2) The direction indicates the anode.

● Taping (Unit:mm)



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| JAPAN | USA | EU | CHINA | |
|---------|-----------|------------|---------|--|
| CLASSⅢ | CL ACCIII | CLASS II b | СГУССШ | |
| CLASSIV | CLASSⅢ | CLASSⅢ | CLASSII | |

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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